Documentation

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5120615-1 Product Details

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5120615-1

Removable Memory Products

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- 50 Positions
- Format = CompactFlash™
- CompactFlash™ Product Type = Header Only
 Header Type = Type I
- Lead Type = Surface Mount Staggered leads

View all Features

Quick Links

- Check Pricing & Availability
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TE Internal Number: 5120615-1











Documentation & Additional Information

Product Drawings:

PIN HEADER ASSEMBLY, 50 POSN, SMT, TOP MOUNT, LOW PR... (PDF, English)

Catalog Pages/Data Sheets:

None Available

Product Specifications:

COMPACT FLASH CARD, 1.27mm(.050") PITCH (PDF, English)

Application Specifications:

None Available

Instruction Sheets:

CAD Files: (CAD Format & Compression Information)

- 2D Drawing (DXF, Version O)
- 3D Model (IGES, Version O)
- 3D Model (STEP, Version O)

Related Products:

Tooling

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Mount Angle = Right Angle
- Profile = Low
- Holddowns = Without
- Color = Black
- Comment = Two size M2 screws (customer supplied) are required for fastening the connector to the PC board.

Mechanical Attachment:

· Mounting Style = Top (Printed Circuit Board)

Electrical Characteristics:

Shielded = No

Termination Related Features:

Solder Tail Contact Plating = Tin

Body Related Features:

- Number of Positions = 50
- CompactFlash™ Product Type = Header Only
- Header Type = Type I
- Lead Type = Surface Mount Staggered leads
- PCB Offset (mm [in]) = 0.00 [0.000]
- Number of Rows = Dual
- Centerline (mm [in]) = 1.27 [0.050]

Contact Related Features:

<u>List all Documents</u>

- Contact Plating, Mating Area, Material = Gold (30)
- Vacuum Tape = Without
- Region = Americas
- Contact Base Material = Beryllium Copper
- Contact Underplating = Nickel

Housing Related Features:

- Housing Material = Liquid Crystal Polymer (LCP)
- UL Flammability Rating = UL 94V-0

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- <u>Lead Free Solder Processes</u> = Reflow solder capable to 245°C, Reflow solder capable to 260°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:

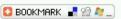
Format = CompactFlash™

Packaging Related Features:

Packaging Method = 72mm Tape & Reel

Other:

Brand = AMP



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